



dsPIC33FJXXXGPX06/X08/X10
Data Sheet

High-Performance,
16-Bit Digital Signal Controllers

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MICROCHIP dsPIC33FJXXXGPX06/X08/X10

High-Performance, 16-Bit Digital Signal Controllers

Operating Range:

- Up to 40 MIPS operation (at 3.0-3.6V):
 - Industrial temperature range (-40°C to +85°C)

High-Performance DSC CPU:

- Modified Harvard architecture
- C compiler optimized instruction set
- 16-bit wide data path
- 24-bit wide instructions
- Linear program memory addressing up to 4M instruction words
- Linear data memory addressing up to 64 Kbytes
- 83 base instructions: mostly 1 word/1 cycle
- Sixteen 16-bit General Purpose Registers
- Two 40-bit accumulators:
 - With rounding and saturation options
- Flexible and powerful addressing modes:
 - Indirect, Modulo and Bit-Reversed
- Software stack
- 16 x 16 fractional/integer multiply operations
- 32/16 and 16/16 divide operations
- Single-cycle multiply and accumulate:
 - Accumulator write back for DSP operations
 - Dual data fetch
- Up to ± 16 -bit shifts for up to 40-bit data

Direct Memory Access (DMA):

- 8-channel hardware DMA:
- 2 Kbytes dual ported DMA buffer area (DMA RAM) to store data transferred via DMA:
 - Allows data transfer between RAM and a peripheral while CPU is executing code (no cycle stealing)
- Most peripherals support DMA

Interrupt Controller:

- 5-cycle latency
- Up to 63 available interrupt sources
- Up to five external interrupts
- Seven programmable priority levels
- Five processor exceptions

Digital I/O:

- Up to 85 programmable digital I/O pins
- Wake-up/Interrupt-on-Change on up to 24 pins
- Output pins can drive from 3.0V to 3.6V
- All digital input pins are 5V tolerant
- 4 mA sink on all I/O pins

On-Chip Flash and SRAM:

- Flash program memory, up to 256 Kbytes
- Data SRAM, up to 30 Kbytes (includes 2 Kbytes of DMA RAM):

System Management:

- Flexible clock options:
 - External, crystal, resonator, internal RC
 - Fully integrated PLL
 - Extremely low jitter PLL
- Power-up Timer
- Oscillator Start-up Timer/Stabilizer
- Watchdog Timer with its own RC oscillator
- Fail-Safe Clock Monitor
- Reset by multiple sources

Power Management:

- On-chip 2.5V voltage regulator
- Switch between clock sources in real time
- Idle, Sleep and Doze modes with fast wake-up

Timers/Capture/Compare/PWM:

- Timer/Counters, up to nine 16-bit timers:
 - Can pair up to make four 32-bit timers
 - 1 timer runs as Real-Time Clock with external 32.768 kHz oscillator
 - Programmable prescaler
- Input Capture (up to eight channels):
 - Capture on up, down or both edges
 - 16-bit capture input functions
 - 4-deep FIFO on each capture
- Output Compare (up to eight channels):
 - Single or Dual 16-Bit Compare mode
 - 16-bit Glitchless PWM mode

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Communication Modules:

- 3-wire SPI (up to two modules):
 - Framing supports I/O interface to simple codecs
 - Supports 8-bit and 16-bit data
 - Supports all serial clock formats and sampling modes
- I²C™ (up to two modules):
 - Full Multi-Master Slave mode support
 - 7-bit and 10-bit addressing
 - Bus collision detection and arbitration
 - Integrated signal conditioning
 - Slave address masking
- UART (up to two modules):
 - Interrupt on address bit detect
 - Interrupt on UART error
 - Wake-up on Start bit from Sleep mode
 - 4-character TX and RX FIFO buffers
 - LIN bus support
 - IrDA® encoding and decoding in hardware
 - High-Speed Baud mode
 - Hardware Flow Control with CTS and RTS
- Data Converter Interface (DCI) module:
 - Codec interface
 - Supports I²S and AC'97 protocols
 - Up to 16-bit data words, up to 16 words per frame
 - 4-word deep TX and RX buffers
- Enhanced CAN (ECAN™ module) 2.0B active (up to 2 modules):
 - Up to eight transmit and up to 32 receive buffers
 - 16 receive filters and three masks
 - Loopback, Listen Only and Listen All Messages modes for diagnostics and bus monitoring
 - Wake-up on CAN message
 - Automatic processing of Remote Transmission Requests
 - FIFO mode using DMA
 - DeviceNet™ addressing support

Analog-to-Digital Converters (ADCs):

- Up to two ADC modules in a device
- 10-bit, 1.1 Msps or 12-bit, 500 ksps conversion:
 - Two, four or eight simultaneous samples
 - Up to 32 input channels with auto-scanning
 - Conversion start can be manual or synchronized with one of four trigger sources
 - Conversion possible in Sleep mode
 - ±1 LSB max integral nonlinearity
 - ±1 LSB max differential nonlinearity

CMOS Flash Technology:

- Low-power, high-speed Flash technology
- Fully static design
- 3.3V (±10%) operating voltage
- Industrial temperature
- Low-power consumption

Packaging:

- 100-pin TQFP (14x14x1 mm and 12x12x1 mm)
- 80-pin TQFP (12x12x1 mm)
- 64-pin TQFP (10x10x1 mm)

Note: See the device variant tables for exact peripheral features per device.
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dsPIC33F PRODUCT FAMILIES

The dsPIC33F General Purpose Family of devices are ideal for a wide variety of 16-bit MCU embedded applications. The controllers with codec interfaces are well-suited for speech and audio processing applications.

The device names, pin counts, memory sizes and peripheral availability of each family are listed below, followed by their pinout diagrams.

dsPIC33F General Purpose Family Controllers

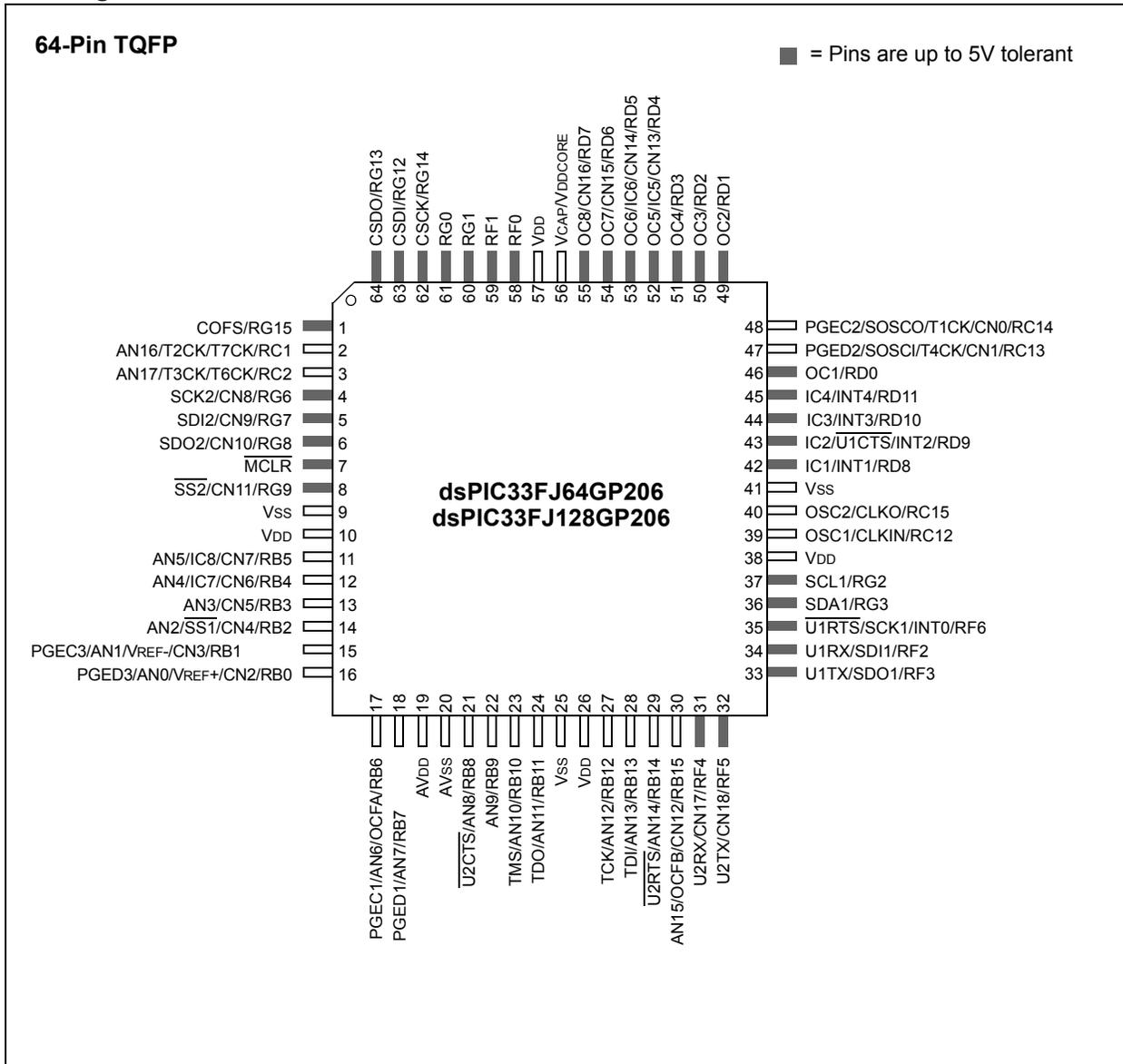
Device	Pins	Program Flash Memory (Kbyte)	RAM (Kbyte) ⁽¹⁾	16-bit Timer	Input Capture	Output Compare Std. PWM	Codec Interface	ADC	UART	SPI	I ² C™	Enhanced CAN™	I/O Pins (Max) ⁽²⁾	Packages
dsPIC33FJ64GP206	64	64	8	9	8	8	1	1 ADC, 18 ch	2	2	1	0	53	PT
dsPIC33FJ64GP306	64	64	16	9	8	8	1	1 ADC, 18 ch	2	2	2	0	53	PT
dsPIC33FJ64GP310	100	64	16	9	8	8	1	1 ADC, 32 ch	2	2	2	0	85	PF, PT
dsPIC33FJ64GP706	64	64	16	9	8	8	1	2 ADC, 18 ch	2	2	2	2	53	PT
dsPIC33FJ64GP708	80	64	16	9	8	8	1	2 ADC, 24 ch	2	2	2	2	69	PT
dsPIC33FJ64GP710	100	64	16	9	8	8	1	2 ADC, 32 ch	2	2	2	2	85	PF, PT
dsPIC33FJ128GP206	64	128	8	9	8	8	1	1 ADC, 18 ch	2	2	1	0	53	PT
dsPIC33FJ128GP306	64	128	16	9	8	8	1	1 ADC, 18 ch	2	2	2	0	53	PT
dsPIC33FJ128GP310	100	128	16	9	8	8	1	1 ADC, 32 ch	2	2	2	0	85	PF, PT
dsPIC33FJ128GP706	64	128	16	9	8	8	1	2 ADC, 18 ch	2	2	2	2	53	PT
dsPIC33FJ128GP708	80	128	16	9	8	8	1	2 ADC, 24 ch	2	2	2	2	69	PT
dsPIC33FJ128GP710	100	128	16	9	8	8	1	2 ADC, 32 ch	2	2	2	2	85	PF, PT
dsPIC33FJ256GP506	64	256	16	9	8	8	1	1 ADC, 18 ch	2	2	2	1	53	PT
dsPIC33FJ256GP510	100	256	16	9	8	8	1	1 ADC, 32 ch	2	2	2	1	85	PF, PT
dsPIC33FJ256GP710	100	256	30	9	8	8	1	2 ADC, 32 ch	2	2	2	2	85	PF, PT

Note 1: RAM size is inclusive of 2 Kbytes DMA RAM.

Note 2: Maximum I/O pin count includes pins shared by the peripheral functions.

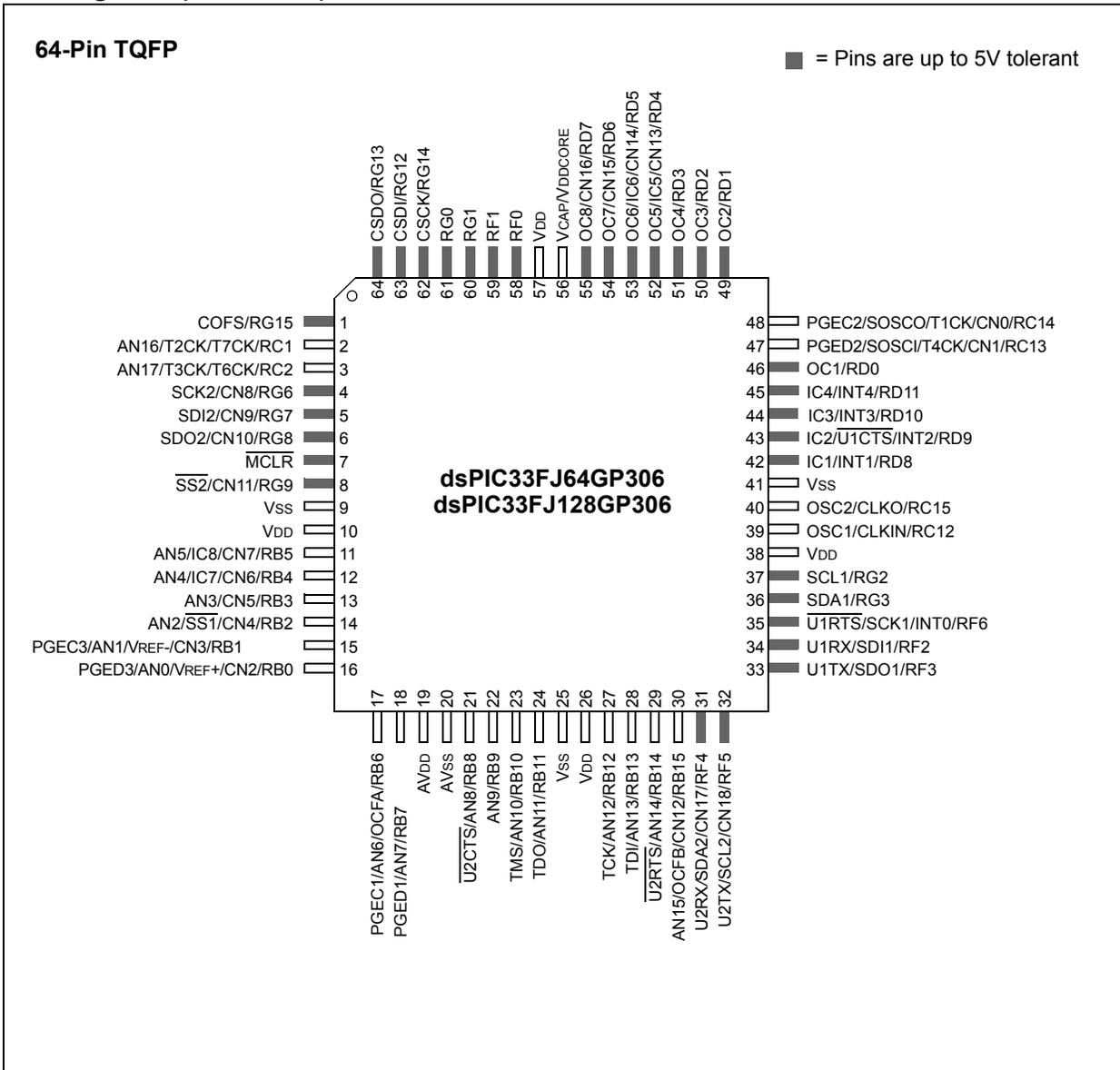
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Pin Diagrams



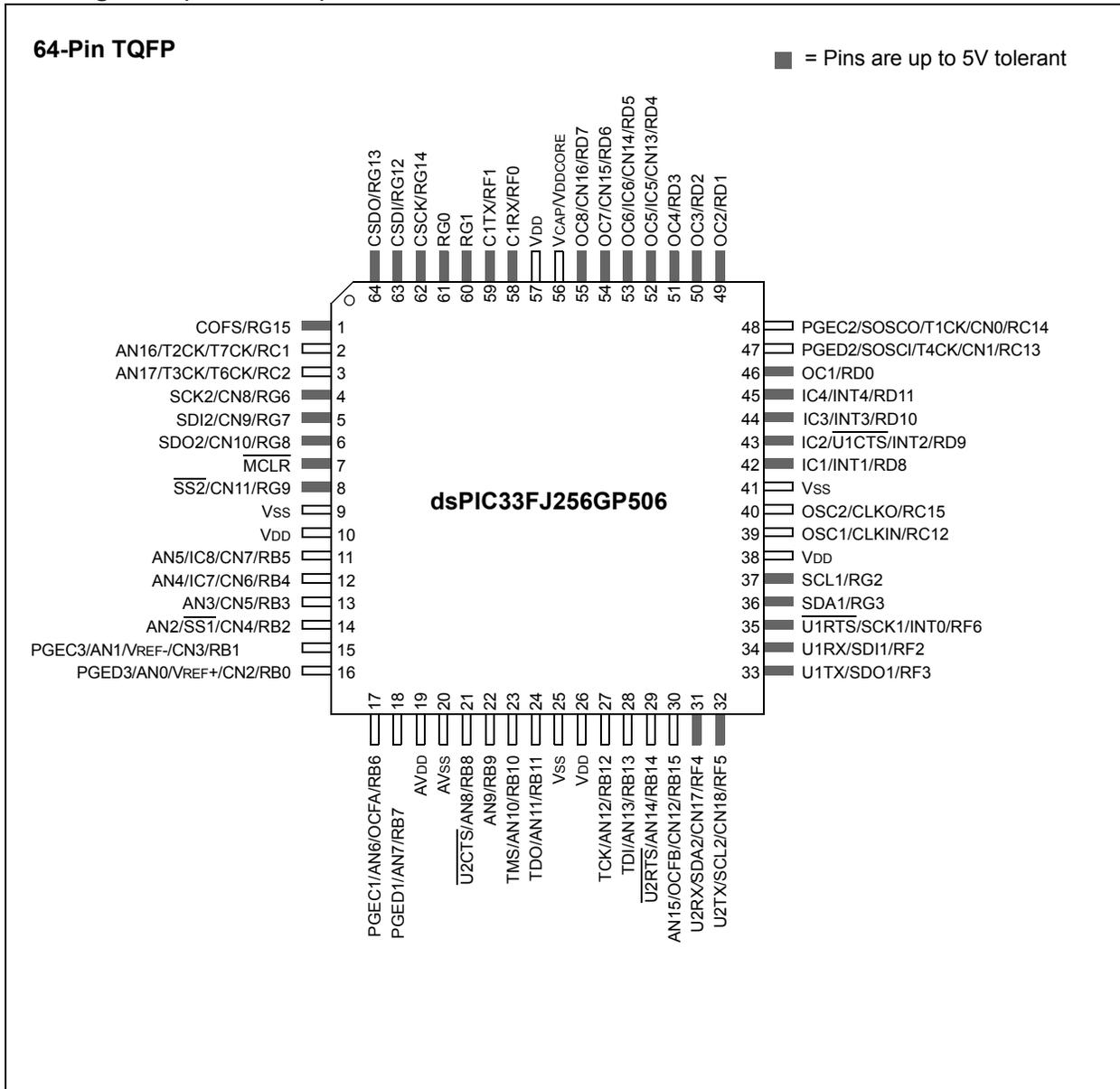
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Pin Diagrams (Continued)



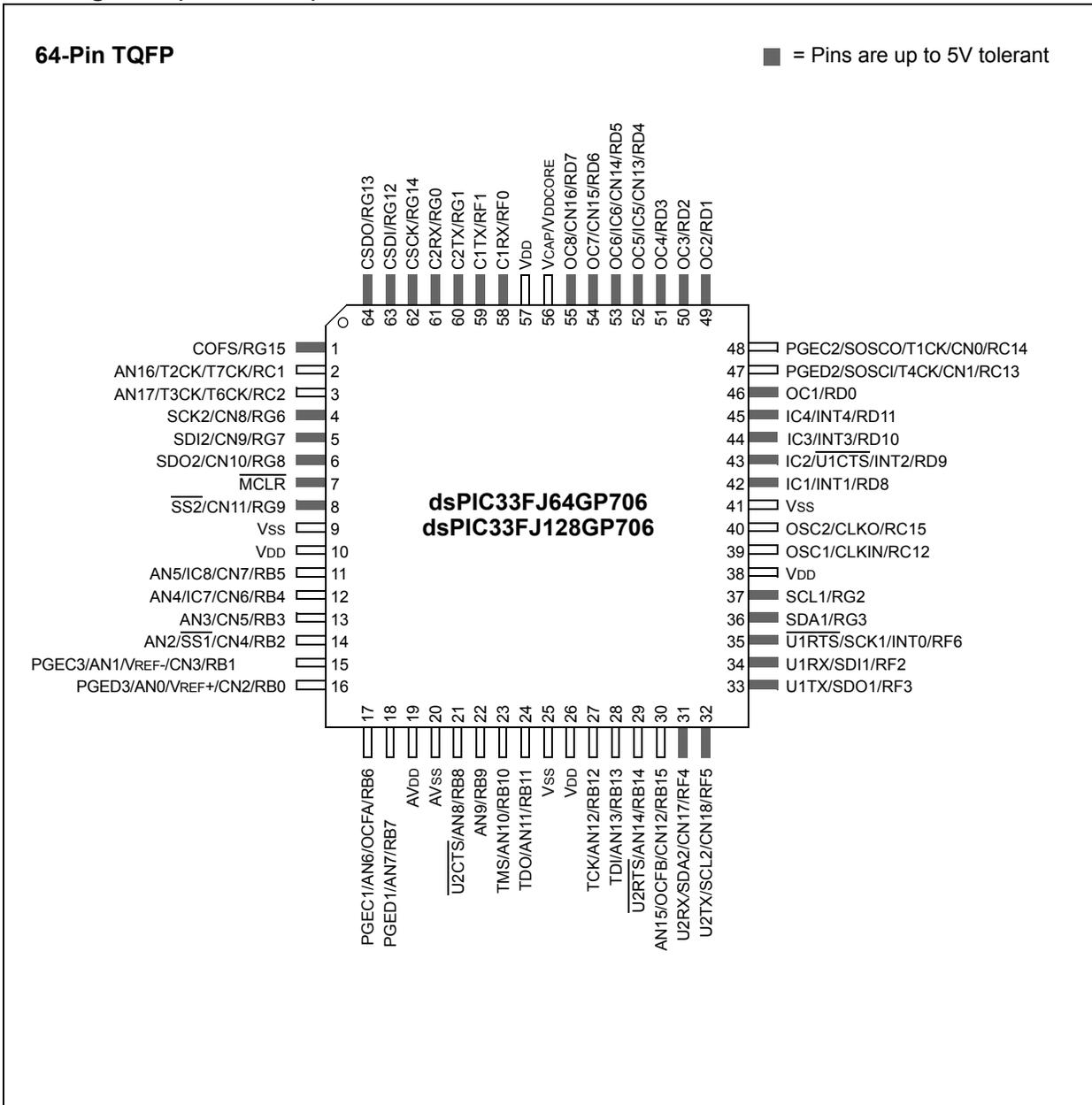
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Pin Diagrams (Continued)



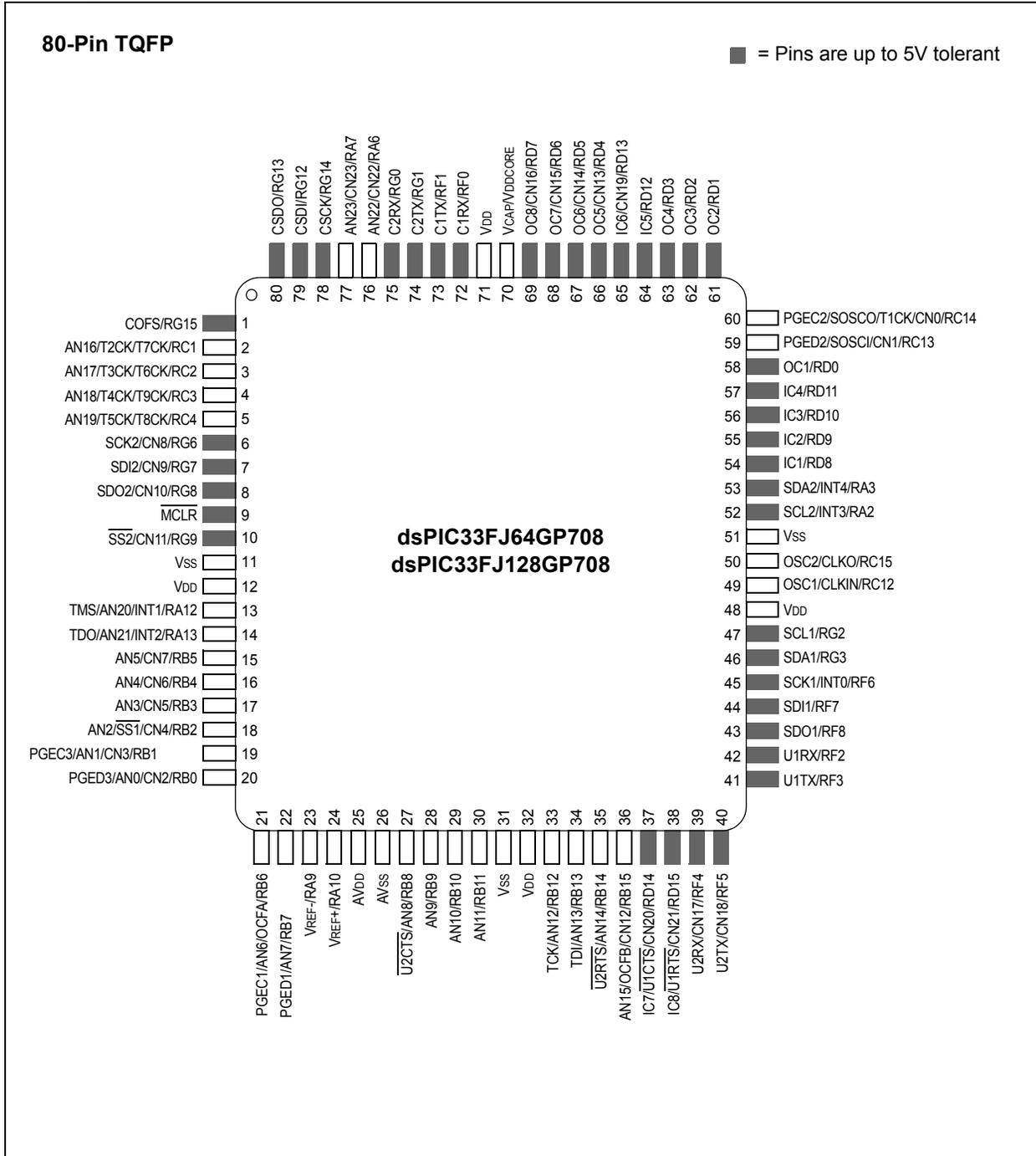
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Pin Diagrams (Continued)



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Pin Diagrams (Continued)



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Pin Diagrams (Continued)

